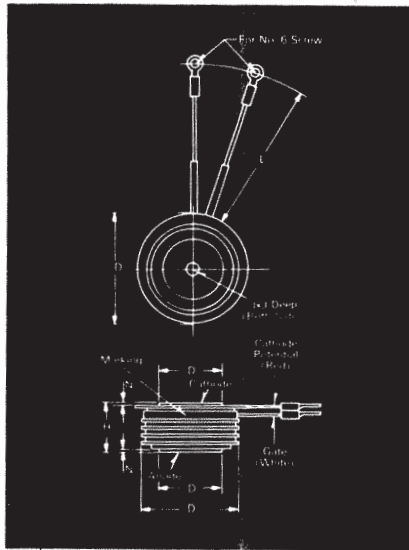


# Fast Switching SCR T9GH\_10

1000A Avg.  
(1570 RMS)  
Up to 1200 Volts  
20-60  $\mu$ s



T9G Outline

## Features:

- Interdigitated, di/namic Gate Structure
- Hard Commutation Turn-Off
- Forward Blocking Capabilities to 1200
- Low Switching Losses at High Frequency
- Soft Commutation (Feedback Diode) Testing Available
- High di/dt with soft gate control

| Symbol                | Inches |       | Millimeters |        |
|-----------------------|--------|-------|-------------|--------|
|                       | Min.   | Max.  | Min.        | Max.   |
| $\phi$ D              | 2.850  | 2.900 | 72.39       | 73.66  |
| $\phi$ D <sub>1</sub> | 1.845  | 1.855 | 46.86       | 47.12  |
| $\phi$ D <sub>2</sub> | 2.560  | 2.640 | 65.02       | 67.06  |
| H                     | 1.030  | 1.070 | 26.16       | 27.18  |
| $\phi$ J              | .135   | .145  | 3.43        | 3.68   |
| J <sub>1</sub>        | .075   | .090  | 1.91        | 2.29   |
| L                     | 11.50  | 12.50 | 292.10      | 317.50 |
| N                     | .050   |       | 1.27        |        |

Creep Distance—1.20 in. min. (30.48 mm).

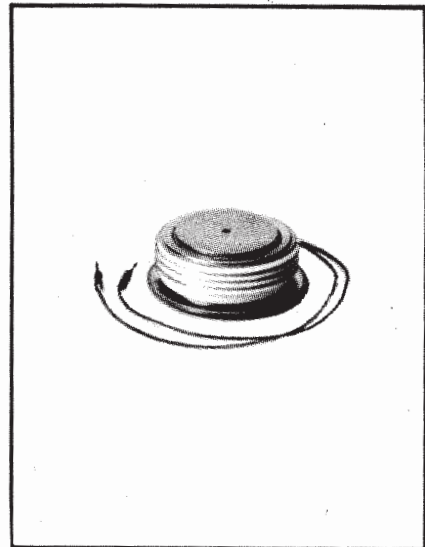
Strike Distance—.70 in. min. (17.78 mm).

(In accordance with NEMA standards.)

Finish—Nickel Plate.

Approx. Weight—2 lb. (908 g).

1. Dimension "H" is a clamped dimension.



## Applications:

- Induction Heating
- Transportation
- Inverters

## Ordering Information

| Type | Voltage                                     |      | Current                |      | Turn-off            |      | Gate current         |      | Leads |      |  |  |
|------|---------------------------------------------|------|------------------------|------|---------------------|------|----------------------|------|-------|------|--|--|
| Code | V <sub>DRM</sub> and V <sub>RRM</sub> * (V) | Code | I <sub>T(av)</sub> (A) | Code | t <sub>q</sub> usec | Code | I <sub>GT</sub> (ma) | Code | Case  | Code |  |  |
| T9GH | 600                                         | 06   | 1000                   | 10   | 20                  | 6    | 300                  | 2    | T9G   | DH   |  |  |
|      | 800                                         | 08   |                        |      | 25                  | 8    |                      |      |       |      |  |  |
|      | 1000                                        | 10   |                        |      | 30                  | 5    |                      |      |       |      |  |  |
|      | 1200                                        | 12   |                        |      | 40                  | 4    |                      |      |       |      |  |  |
|      |                                             |      |                        |      | 50                  | 3    |                      |      |       |      |  |  |
|      |                                             |      |                        |      | 60                  | 2    |                      |      |       |      |  |  |

## Example

Obtain optimum device performance for your application by selecting proper order code.

Type T9GH rated at 1000A average with V<sub>DRM</sub> = 1000V

t<sub>q</sub> = 30 usec.

I<sub>GT</sub> = 300 ma, and standard 12 inch leads -- order as:

\*for lower voltages consult factory

| Type    | Voltage | Current | Turn Off | Gate Current | Leads |
|---------|---------|---------|----------|--------------|-------|
| T 9 G H | 1 0     | 1 0     | 5        | 2            | D H   |

**1000A Avg.  
(1570 RMS)  
Up to 1200 Volts  
20-60  $\mu$ s**

**Fast Switching  
SCR  
T9GH\_10**

## Voltage

Blocking State Maximums <sup>(1)</sup> ( $T_J = 125^\circ\text{C}$ )

Repetitive peak forward blocking voltage, V ...  
Repetitive peak reverse voltage, V ...  
Non-repetitive transient peak reverse voltage,  
 $t \leq 5.0$  msec, V ...  
Forward leakage current, mA peak ...  
Reverse leakage current, mA peak ...

| Symbol    | 600 | 800 | 1000 | 1200 |
|-----------|-----|-----|------|------|
| $V_{DRM}$ | 600 | 800 | 1000 | 1200 |
| $V_{RRM}$ | 600 | 800 | 1000 | 1200 |
| $V_{RSM}$ | 700 | 900 | 1100 | 1300 |
| $I_{DRM}$ | 90  |     |      |      |
| $I_{RRM}$ | 90  |     |      |      |

## Current

Conducting State Maximums  
( $T_J = 125^\circ\text{C}$ )

| Symbol                                                                                        | T9GH_10              |
|-----------------------------------------------------------------------------------------------|----------------------|
| RMS forward current, A ... $I_T(\text{rms})$                                                  | 1570                 |
| Ave. forward current, A ... $I_T(\text{av})$                                                  | 1000                 |
| One-half cycle surge current <sup>(2)</sup> , A ... $I_{TSM}$                                 | 15,000               |
| $I^2t$ for fusing ( $t = 8.3$ ms), A <sup>2</sup> sec ... $I^2t$                              | 937,000              |
| Max $I^2t$ of package ( $t = 8.3$ ms), A <sup>2</sup> sec ... $I^2t$                          | 90 x 10 <sup>6</sup> |
| Forward voltage drop at $I_T = 1500\text{A}$<br>and $T_J = 25^\circ\text{C}$ , V ... $V_{TM}$ | 2.10                 |
| Min. Repetitive $di/dt$ ... A/usec. <sup>(1)</sup> <sup>(4)</sup> <sup>(5)</sup> $di/dt$      | 500                  |

## Gate

( $T_J = 25^\circ\text{C}$ )

| Symbol                                                                                            | Min | Typ | Max |
|---------------------------------------------------------------------------------------------------|-----|-----|-----|
| Gate current to trigger at $V_D = 12\text{V}$ , mA ... $I_{GT}$                                   |     | 200 | 300 |
| Gate voltage to trigger at $V_D = 12\text{V}$ , V ... $V_{GT}$                                    |     | 1.5 | 3.0 |
| Non-triggering gate voltage, $T_J = 125^\circ\text{C}$ ,<br>and rated $V_{DRM}$ , V ... $V_{GDM}$ |     |     | .15 |
| Non-triggering Gate Current at<br>$V_D = 12\text{V}$ , mA ... $I_{GNT}$                           |     | 20  |     |
| Peak forward gate current, A ... $I_{GTM}$                                                        |     |     | 10  |
| Peak reverse gate voltage, V ... $V_{GRM}$                                                        |     |     | 5   |
| Peak gate power, Watts ... $P_{GM}$                                                               |     |     | 60  |
| Average gate power, Watts ... $P_{G(av)}$                                                         |     |     | 3   |

## Switching

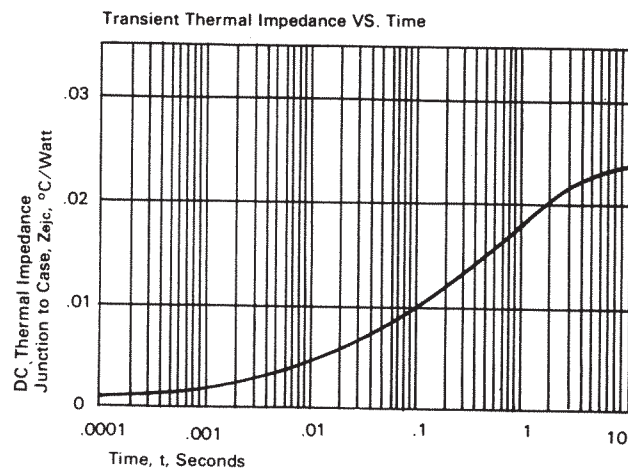
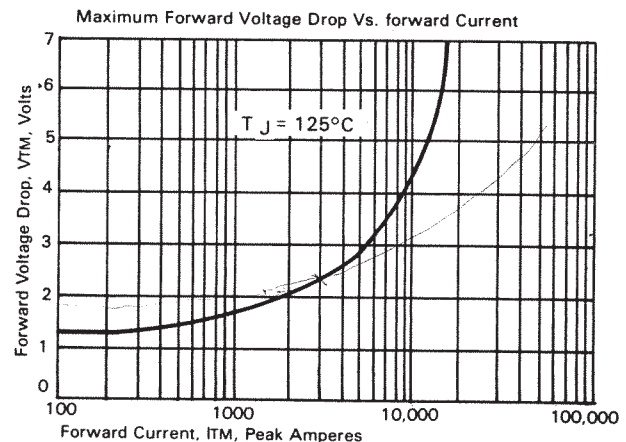
( $T_J = 25^\circ\text{C}$ )

| Symbol                                                                                                                                                                                                            |       |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| <b>HARD COMMUTATION: <sup>(1)</sup></b>                                                                                                                                                                           |       |
| Typical Turn-off time, $I_T = 1000\text{A}$<br>$50\text{V} \leq V_R \leq V_{RRM}$<br>$T_J = 125^\circ\text{C}$ , $di/dt = 100\text{A}/\mu\text{sec}$<br>reapplied $dv/dt =$ ...                                   | 20-60 |
| Typical Turn-On and Delay Time<br>$I_{TM} = 1000\text{A}$ , $t_p = 450 \mu\text{sec}$ ... $t_{on}$                                                                                                                | 3.0   |
| $V_D = 1100\text{V}$ , $\mu\text{sec}$ ... $t_d$                                                                                                                                                                  | 1.5   |
| Typical Reverse recovery charge for 40<br>$\mu\text{sec}$ device.<br>$I_T = 1000\text{A}$ , $di/dt = 100\text{A}/\mu\text{sec}$<br>$T_J = 125^\circ\text{C}$ , $t_p = 100 \mu\text{sec}$ , $u_{col}$ ... $Q_{RR}$ | 260   |
| Minimum Critical $dv/dt$ exponential<br>to $V_{DRM}$<br>$T_J = 125^\circ\text{C}$ , V/ $\mu\text{sec}$ <sup>(1)</sup> <sup>(2)</sup> ... $dv/dt$                                                                  | 400   |
| Minimum $di/dt$ @ non-repetitive,<br><sup>(1)</sup> <sup>(2)</sup> <sup>(3)</sup> A/ $\mu\text{sec}$ ... $di/dt$                                                                                                  | 1000  |
| Latching Current<br>$V_D = 75\text{V}$ , mA ... $I_L$                                                                                                                                                             | 500   |
| Holding Current<br>$V_D = 75\text{V}$ , ma ... $I_H$                                                                                                                                                              | 1000  |
|                                                                                                                                                                                                                   | 300   |
|                                                                                                                                                                                                                   | 800   |

## Thermal and Mechanical

| Symbol                                                                                                                               | Min  | Typ | Max   |
|--------------------------------------------------------------------------------------------------------------------------------------|------|-----|-------|
| Oper. junction temp., $^\circ\text{C}$ ... $T_J$                                                                                     | -40  |     | 125   |
| Storage temp., $^\circ\text{C}$ ... $T_{stg}$                                                                                        | -40  |     | 150   |
| Mounting force, lb. ...                                                                                                              | 5000 |     | 5500  |
| Thermal resistance<br>with double sided cooling <sup>(1)</sup><br>Junction to case, $^\circ\text{C}/\text{Watt}$ ... $R_{\theta JC}$ |      |     | .023  |
| Case to sink, lubricated, $^\circ\text{C}/\text{Watt}$ ... $R_{\theta CS}$                                                           | .006 |     | .0075 |

- <sup>(1)</sup> Consult recommended mounting procedures.
- <sup>(2)</sup> Applies for zero or negative gate bias.
- <sup>(3)</sup> Per JEDEC RS-397, 5.2.2.1.
- <sup>(4)</sup> With recommended gate drive.
- <sup>(5)</sup> For different turn-off values or conditions, consult factory.
- <sup>(6)</sup> Per JEDEC standard RS-397, 5.2.2.6.
- <sup>(7)</sup> For operation with antiparallel diode, consult factory.



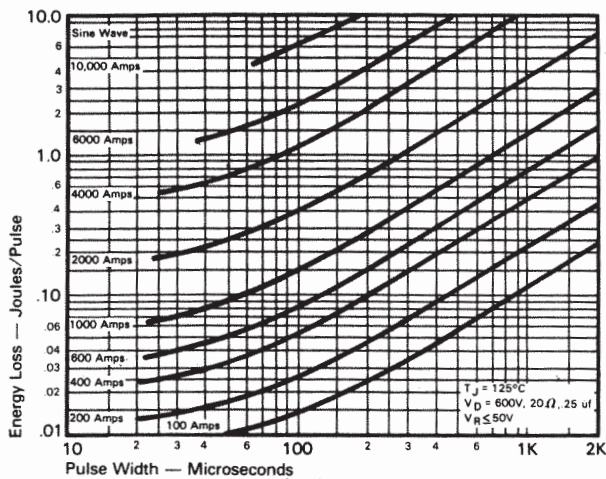
Information presented is based upon manufacturers testing and projected capabilities.  
This information is subject to change without notice.  
The manufacturer makes no claim as to the suitability of use, reliability, capability,  
or future availability of this product.



# Fast Switching SCR T9GH\_10

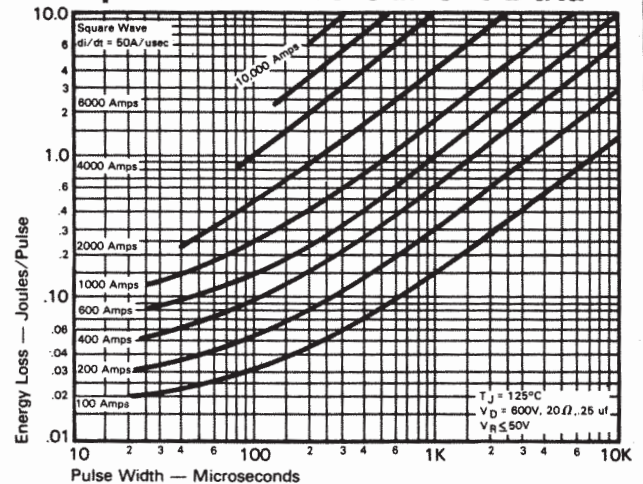
1000A Avg.  
(1570 RMS)  
Up to 1200 Volts  
20-60  $\mu$ s

## Sinusoidal Current Data

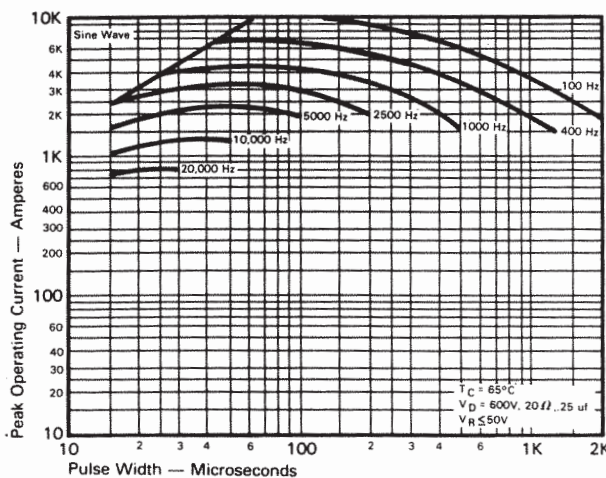


ENERGY PER PULSE FOR SINUSOIDAL PULSES

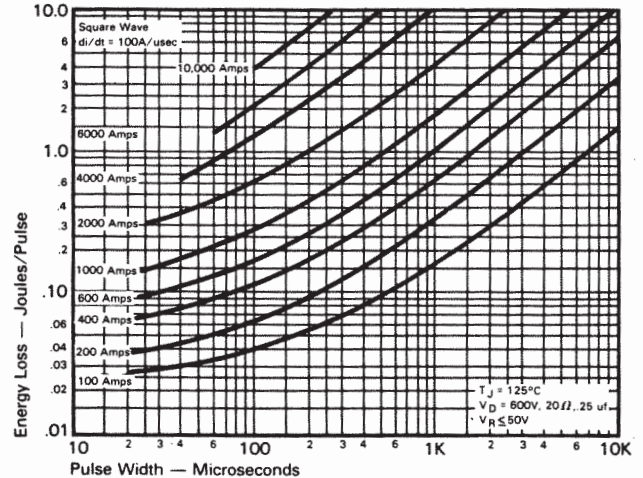
## Trapezoidal Wave Current Data



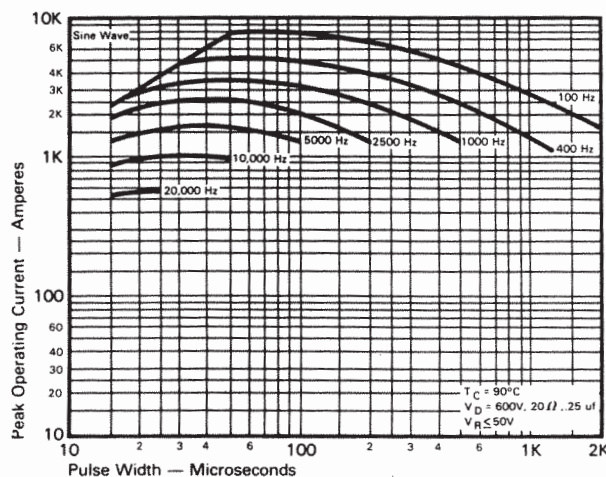
ENERGY PER PULSE FOR TRAPEZOIDAL PULSES  
( $di/dt = 50\text{A}/\mu\text{sec}$ )



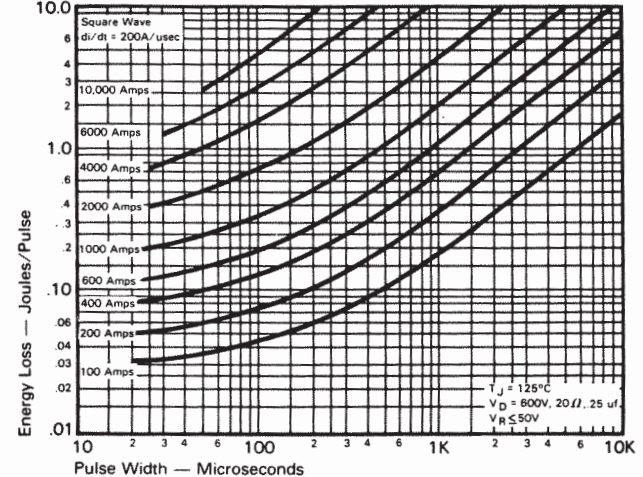
MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT  
vs. PULSE WIDTH ( $T_C = 65^\circ\text{C}$ )



ENERGY PER PULSE FOR TRAPEZOIDAL PULSES  
( $di/dt = 100\text{A}/\mu\text{sec}$ )



MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT  
vs. PULSE WIDTH ( $T_C = 90^\circ\text{C}$ )



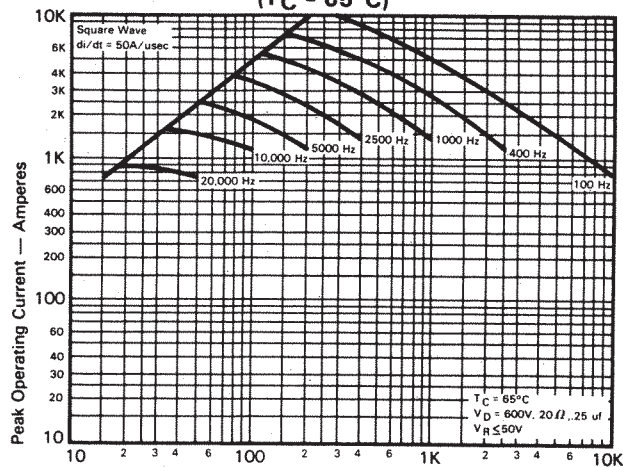
ENERGY PER PULSE FOR TRAPEZOIDAL PULSES  
( $di/dt = 200\text{A}/\mu\text{sec}$ )

FAST SWITCHING  
THYRISTORS

1000A Avg.  
(1570 RMS)  
Up to 1200 Volts  
20-60  $\mu$ s

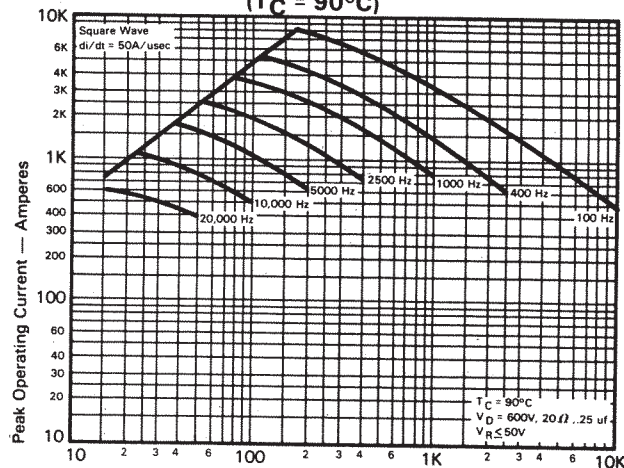
Fast Switching  
SCR  
T9GH\_10

**Trapezoidal Wave Current Data**  
( $T_C = 65^\circ\text{C}$ )

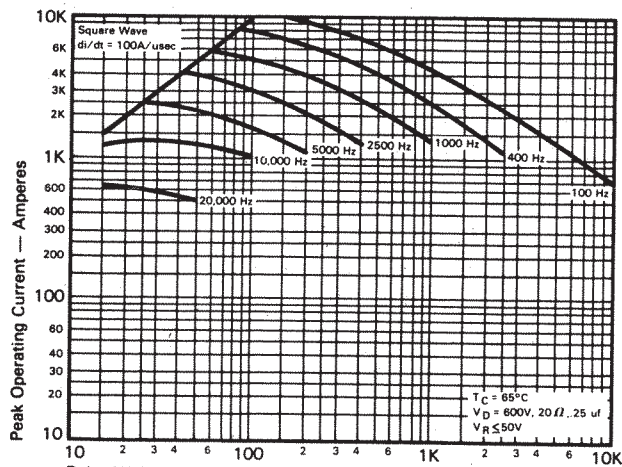


**MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs. PULSE WIDTH ( $di/dt = 50\text{A}/\mu\text{sec}$ )**

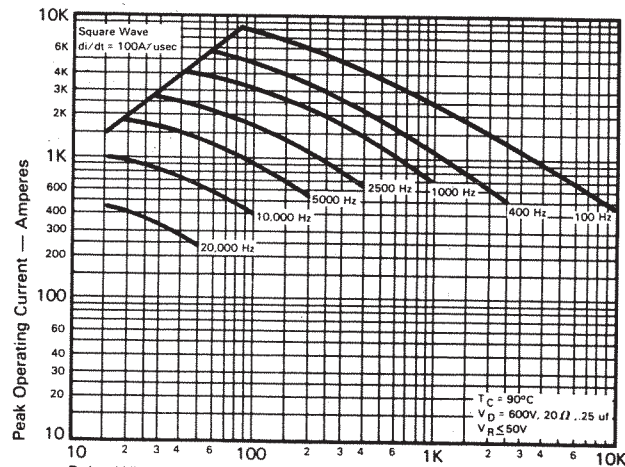
**Trapezoidal Wave Current Data**  
( $T_C = 90^\circ\text{C}$ )



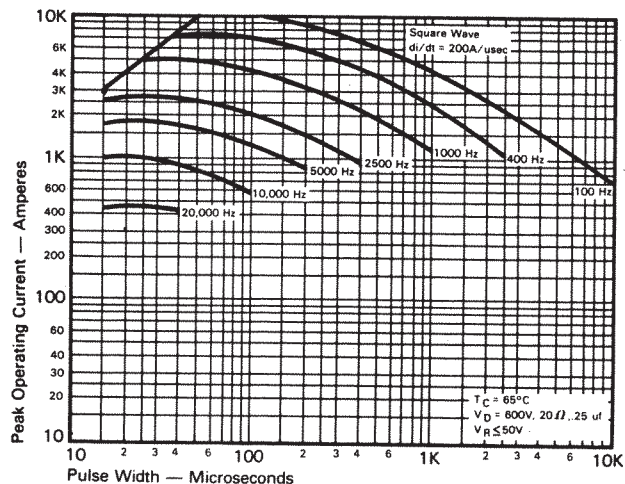
**MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs. PULSE WIDTH ( $di/dt = 50\text{A}/\mu\text{sec}$ )**



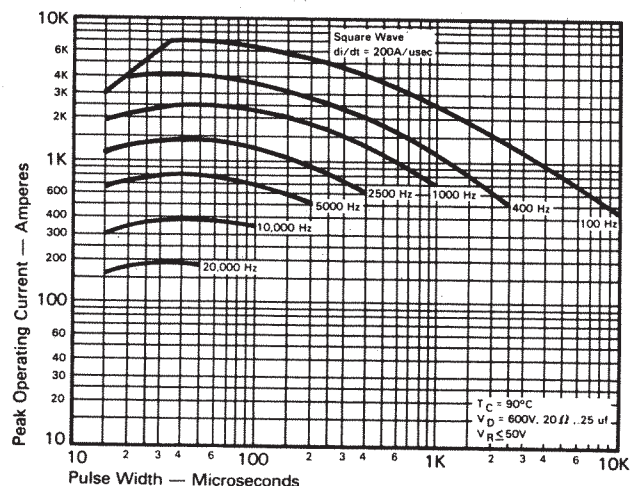
**MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs. PULSE WIDTH ( $di/dt = 100\text{A}/\mu\text{sec}$ )**



**MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs. PULSE WIDTH ( $di/dt = 100\text{A}/\mu\text{sec}$ )**



**MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs. PULSE WIDTH ( $di/dt = 200\text{A}/\mu\text{sec}$ )**



**MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs. PULSE WIDTH ( $di/dt = 200\text{A}/\mu\text{sec}$ )**